Central Electricity Authority
Information Technology Division
Sewa Bhawan, R. K. Puram, New Delhi

No.: CEA/PCE-I/IT/PLAN/UITI/2015/417   Date: 30.09.2015

CORRIGENDUM

In the e-Tender for Supply & Installation of Desktop Computer & MS Office in CEA (No. CEA/PCE-I/ IT/ PLAN/UITI/2015, Dated: 16.09.2015), the following clauses are modified as under:

Clause 6.6.1: The words & figures "*clause 6.1.18*" shall be substituted by "*clause 6.18*" and the words & figures "*Clarification / Queries received, only, by 11:00 am on 5th October, 2015, will be entertained*" shall be inserted after the first sentence.

Clause 6.8.3: The following words & figures shall be inserted after the last sentence:

> "*If during the installation & commissioning, it is found that more than 10% of the ordered quantity of Desktop Computers fail to perform as per technical specifications, then the purchaser shall have right to reject all the Desktop computers supplied and the Performance Security shall be encashed.*"

Clause 6.8.4: Deleted

Clause 6.9.1: The words "*after completion of supply, installation & commissioning*" shall be deleted.

Clause 6.11.5: The words "*or abroad*" shall be deleted.

Clause 6.18: The figures "*6.13*" shall be replaced by "*6.14*".

Annexure-I & V of Part-VII: In the table at Annexure-I, the words & figures under the column **Specifications required** in the rows with Sl. No: 2, 8, 9, 10 and 16 & in the table at Annexure-V, the words & figures under the column **Specifications offered** at rows with Sl. No.: 3, 9, 10, 11 and 17 shall be replaced as given below:

Sl.No of Annexure-I	Sl.No of Annexure-V	Component	Specification required/ Specification Offered
2.	3.	Chipset	Intel Q87 or higher Chipset; OEM motherboard with OEM's name printed/embossed on it (no sticker); BIOS Diagnostic tool.
8.	9.	Cabinet	Tower; SMPS Efficiency: 85% or more; Tool Less Manageability (Tool- less Hood, HDD and ODD removal for easier upgrades and repairs).
9.	10.	Monitor	18.5" wide / flat (or more/better) TFT monitor with TCO 06 Certification; Energy Star compliant Version 5.2 or later.
10.	11.	Keyboard	104 keys USB Keyboard
16.	17.	Compliance	RoHS(Restriction of Hazardous Substances); Energy Star compliant Version 5.2 or later; IPv4 and IPv6 compliant; EPEAT Gold

Modified *Annexure-I* and *Annexure-V* are enclosed.

7.1 ANNEXURE-I: TECHNICAL SPECIFICATIONS

S.No.	Component	Specification required
1.	Processor	Intel Core i7-4770, 3.4 GHz, 8 MB Cache or higher
2.	Chipset	Intel Q87 or higher Chipset; OEM motherboard with OEM's name printed/embossed on it (no sticker); BIOS Diagnostic tool
3.	Bus-Architecture	3 PCI (PCI/PCI Express) or more
4.	Memory	8 GB, 1600 MHz, DDR-III expandable up to 32 GB
5.	Hard Disk	1 TB SATA HDD 7200 RPM
6.	Network facility	10/100/1000 on board integrated Network Port with remote booting facility remote system installation
7.	Ports	6 USB Ports (at least 2 USB 3.0), RJ45, Audio in/out, Headphone and Microphone, VGA Port.
8.	Cabinet	Tower; SMPS Efficiency: 85% or more; Tool Less Manageability (Tool- less Hood, HDD and ODD removal for easier upgrades and repairs)
9.	Monitor	18.5" wide / flat (or more/better) TFT monitor with TCO 06 Certification; Energy Star compliant Version 5.2 or later
10.	Keyboard	104 keys USB keyboard
11.	Mouse	USB Optical Mouse
12.	Bays	2 Nos. or more
13.	Operating System	Preloaded Windows 8.1 Professional with 64 bit license (with Recovery DVD Media)
14.	Security	Trusted Platform Module (TPM) Version 1.2 or later
15.	OS Certification	Windows 8.1 Professional OS/ Linux certification
16.	Compliance	RoHS(Restriction of Hazardous Substances); Energy Star compliant Version 5.2 or later; IPv4 and IPv6 compliant; EPEAT Gold
17.	Backup & Recovery	Integrated Data Back-up and Recovery Solution (for Data, Application & OS)
18.	Microsoft Office 2013 or later Standard version	Microsoft Open Licensing Policy (MOLP) with Media, Bilingual
19.	Microsoft Office 2013 or later Professional Plus version	Microsoft Open Licensing Policy (MOLP) with Media, Bilingual
20.	Warranty	Five years (5) on-site warranty

Signature & Seal of the Bidder

7.5 Annexure-V: COMPLIANCE SHEET FOR SPECIFICATIONS

S.No	Component	Specification offered	Comply (Y/N)
1.	Model & Make		
2.	Processor	Intel Core i7-4770, 3.4 GHz, 8 MB Cache or higher	
3.	Chipset	Intel Q87 or higher Chipset; OEM motherboard with OEM's name printed/embossed on it (no sticker); BIOS Diagnostic tool	
4.	Bus-Architecture	3 PCI (PCI/PCI Express) or more	
5.	Memory	8 GB, 1600 MHz, DDR-III expandable up to 32 GB	
6.	Hard Disk	1 TB SATA HDD 7200 RPM	
7.	Network facility	10/100/1000 on board integrated Network Port with remote booting facility remote system installation	
8.	Ports	6 USB Ports (at least 2 USB 3.0), RJ45, Audio in/out, Headphone and Microphone, VGA Port.	
9.	Cabinet	Tower; SMPS Efficiency: 85% or more; Tool Less Manageability (Tool- less Hood, HDD and ODD removal for easier upgrades and repairs)	
10.	Monitor	18.5" wide / flat (or more/better) TFT monitor with TCO 06 Certification; Energy Star compliant Version 5.2 or later	
11.	Keyboard	104 keys USB keyboard	
12.	Mouse	USB Optical Mouse	
13.	Bays	2 Nos. or more	
14.	Operating System	Preloaded Windows 8.1 Professional with 64 bit license (with Recovery DVD Media)	
15.	Security	Trusted Platform Module (TPM) Version 1.2 or later	
16.	OS Certification	Windows 8.1 Professional OS/ Linux certification	
17.	Compliance	RoHS(Restriction of Hazardous Substances); Energy Star compliant Version 5.2 or later; IPv4 and IPv6 compliant; EPEAT Gold	
18.	Backup & Recovery	Integrated Data Back-up and Recovery Solution (for Data, Application & OS)	
19.	Microsoft Office 2013 or later Standard version	Microsoft Open Licensing Policy (MOLP) with Media, Bilingual	
20.	Microsoft Office 2013 or later Professional Plus version	Microsoft Open Licensing Policy (MOLP) with Media, Bilingual	
21.	Warranty	Five years (5) on-site warranty	

Signature & Seal of the Bidder